Date: Sep. 25, 2018

RENESAS TECHNICAL UPDATE

TOYOSU FORESIA, 3-2-24, Toyosu, Koto-ku, Tokyo 135-0061, Japan Renesas Electronics Corporation

Product Category	MPU/MCU	Document No.	TN-RX*-A201A/E	Rev.	1.00		
Title	Errata to RX230 Group, RX231 Group User's Hardware	Information Category	Technical Notification				
		Lot No.		RX230 Group, RX231	ger'g		
Applicable Product	RX230 Group, RX231 Group	All	Reference Document	Manual: Hardware Rev.1.10 (R01UH0496EJ0110) Technical Update TN-RX*-A200A/E			

This document describes corrections to the RX230 Group, RX231 Group User's Manual: Hardware, Rev.1.10.

The corrections are indicated in red in the lists below.

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Description for the VCC_USB in the USB 2.0 host/function module in Table 1.5 is modified as follows.

Before correction

Classifications	Pin Name	I/O	Description			
USB 2.0 host/	VCC_USB	Input	Power supply pin for USB. Connect this pin to VCC.			
function module	VSS_USB	Input	Ground pin for USB. Connect this pin to VSS.			
			(Omitted)			

After correction

Classifications	Pin Name	I/O	Description
USB 2.0 host/ function module	VCC_USB	Input	Power supply pin for USB. Connect this pin to VCC or connect this pin to VSS via a $0.33~\mu\text{F}$ smoothing capacitor for stabilizing the internal power supply.
	VSS_USB	Input	Ground pin for USB. Connect this pin to VSS.
			(Omitted)

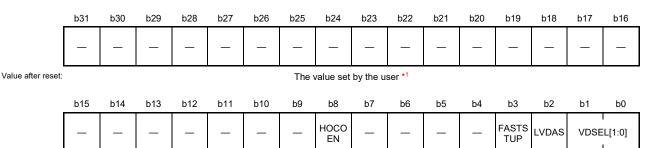


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The address of "FFFF 7F88h" is added to the address field in 7.2.2 as follows (TN-RX*-A200A/E).

Before correction

Address(es): FFFF FF88h



Value after reset:

The value set by the user *1

(Omitted)

Note 1. The value of the blank product is FFFF FFFFh. It is set to the written value after written by the user.

After correction

Address(es): FFFF FF88h, (FFFF 7F88h)*1

_	b31	b30	b29	b28	b27	b26	b25	b24	b23	b22	b21	b20	b19	b18	b17	b16
	_	_	_	-	_	_	-	_	_	-	_	-	_	_	_	_
Value after reset:			I		I		The	value set	by the u	ser *2				l.		
_	b15	b14	b13	b12	b11	b10	b9	b8	b7	b6	b5	b4	b3	b2	b1	b0
								носо					FASTS	11/046	VDSE	1 [4.0]

Value after reset:

The value set by the user *2

ΕN

(Omitted)

- Note 1. Set the same value to this address when using start-up program protection.
- Note 2. The value of the blank product is FFFF FFFFh. This register is set to a specified value after programming of the flash memory with the user program.

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LVDAS

TUP

VDSEL[1:0]

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The setting example is added to 7.3.1 as follows.

Before correction

Since the option-setting memory is allocated in the ROM, values cannot be written by executing instructions. Write appropriate values when writing the program. An example of the settings is shown below.

- To set ffff fff8h in the OFS0 register
 - .org 0ffff ff8ch
 - .lword 0ffffff8h

After correction

Since the option-setting memory is allocated in the ROM, values cannot be written by executing instructions. Write appropriate values when writing the program. Examples of the settings are shown below.

- To set FFFF FFF8h in the OFS0 register
 - .ORG 0FFFFF8CH
 - .LWORD 0FFFFFF8H
- To set FFFF FEF0h in the OFS1 register
 - .ORG 0FFFFF88H
 - .LWORD 0FFFFFEF0H
 - .ORG 0FFF7F88H
 - .LWORD 0FFFFFEF0H

When neither the voltage monitoring 0 reset nor power-on fast startup time is used, the value set in the address FFFF 7F88h can be FFFF FFFFh.

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Note in section 20.3.6 is modified as follows.

Before correction

Note: If event link output from the RTC is to be used, make the ELC settings after the RTC settings (initialization, time setting, etc.). Unintended events may be generated if RTC settings are made after the ELC settings.

After correction

Note: If event signal output from the RTC is to be used, make the ELC settings after the RTC settings (initialization,

time setting, etc.). Unintended events may be generated if RTC settings are made after the ELC settings.

Note: If event signal output from the LVD is to be used, make the ELC settings after the LVD settings. When the LVD is to be disabled, set the corresponding ELSRn register to 00h in advance.

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Description of the address field in section 21.3.6 is corrected as follows.

Before correction

PORT1.ODR1 0008 C083h, PORT2.ODR1 0008 C085h, PORT3.ODR1 0008 C087h, PORT5.ODR1 0008 C08Bh, Address(es): PORT7.ODR1 0008 C08Fh, PORT9.ODR1 0008 C093h, PORTA.ODR1 0008 C095h, PORTB.ODR1 0008 C097h, PORTC.ODR1 0008 C099h, PORTE.ODR1 0008 C09Dh

After correction

Address(es): PORT1.ODR1 0008 C083h, PORT2.ODR1 0008 C085h, PORT3.ODR1 0008 C087h, PORT5.ODR1 0008 C08Bh, PORTA.ODR1 0008 C095h, PORTB.ODR1 0008 C097h, PORTC.ODR1 0008 C099h, PORTE.ODR1 0008 C09Dh

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Values in Table 50.18 are corrected as follows.

Before correction

Item					Min.	Max.	Unit	Test Conditions
Output low	All output ports	Normal output mode		V _{OL}	_	0.8	V	I _{OL} = 0.5 mA
		High-drive output mode			_	0.8		I _{OL} = 1.0 mA
Outpu high	All output ports	Normal output mode	Ports 03, 05, 07, Ports 40 to 47	V _{OH}	AVCC0 - 0.5		V	$I_{OH} = -0.5 \text{ mA}$
			Ports other than above		VCC - 0.5			
		High-drive outp	ut mode		VCC - 0.5	_		$I_{OH} = -1.0 \text{ mA}$

After correction

Item					Min.	Max.	Unit	Test Conditions
Output low	All output ports	Normal output mode		V _{OL}	_	0.3	V	$I_{OL} = 0.5 \text{ mA}$
		High-drive output mode			_	0.3		I _{OL} = 1.0 mA
Outpu high	All output ports	Normal output mode	Ports 03, 05, 07, Ports 40 to 47	V _{OH}	AVCC0 - 0.3	_	V	$I_{OH} = -0.5 \text{ mA}$
			Ports other than above		VCC - 0.3	_		
		High-drive outp	ut mode		VCC - 0.3			$I_{OH} = -1.0 \text{ mA}$

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Values in Table 50.19 are corrected as follows.

Before correction

ltem					Min.	Max.	Unit	Test Conditions
Output low	All output ports Normal output mode		V _{OL}	_	8.0	V	I _{OL} = 1.0 mA	
	(except for RIIC)	High-drive outp	ut mode		_	8.0		I _{OL} = 2.0 mA
RIIC pins		Standard mode mode)	(Normal output		_	0.4		I _{OL} = 3.0 mA
	Fast mode (High-drive output mode)			_	0.6		I _{OL} = 6.0 mA	
Outpu high	u high All output ports Normal output Ports 03, 05, 07, mode Ports 40 to 47		, , ,	V _{OH}	AVCC0 - 0.8	_	V	I _{OH} = -1.0 mA
			Ports other than above		VCC - 0.8	_		
High-drive output mode			ut mode		VCC - 0.8	_		I _{OH} = -2.0 mA

After correction

ltem					Min.	Max.	Unit	Test Conditions
Output low	tput low All output ports Normal output mode		V _{OL}	_	0.5	V	I _{OL} = 1.0 mA	
	(except for RIIC)	High-drive outp	out mode		_	0.5		I _{OL} = 2.0 mA
	RIIC pins Standard mode (Normal output mode) Fast mode (High-drive output mode)			_	0.4		I _{OL} = 3.0 mA	
				_	0.6		I _{OL} = 6.0 mA	
Outpu high	All output ports	Normal output mode	Ports 03, 05, 07, Ports 40 to 47	V _{OH}	AVCC0 - 0.5	_	V	$I_{OH} = -0.5 \text{ mA}$
			Ports other than above		VCC - 0.5	_		
		High-drive outp	out mode		VCC - 0.5	_		I _{OH} = -2.0 mA

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Figure 50.12 is corrected as follows.

Before correction

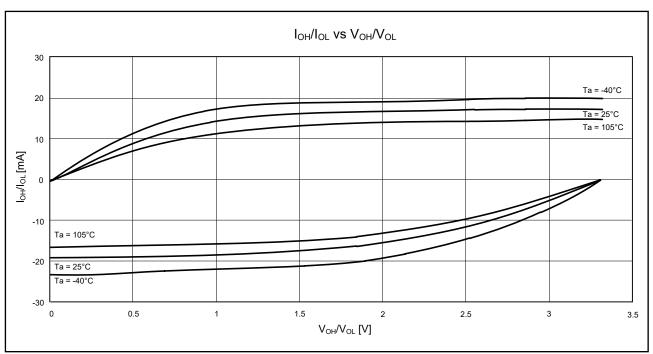


Figure 50.12 V_{OH}/V_{OL} and I_{OH}/I_{OL} Temperature Characteristics at VCC = 5.5 V When Normal Output is Selected (Reference Data)

After correction

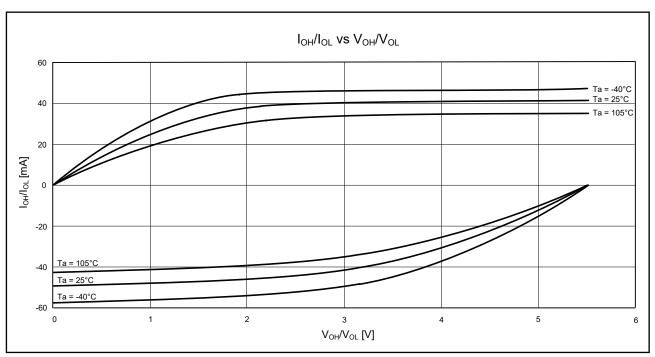


Figure 50.12 V_{OH}/V_{OL} and I_{OH}/I_{OL} Temperature Characteristics at VCC = 5.5 V When Normal Output is Selected (Reference Data)